

PNP Silicon Digital Transistor

- Switching circuit, inverter, interface circuit, driver circuit
- Built in bias resistor (R_1 = 10 k Ω , R_2 = 47 k Ω)
- BCR185S: Two internally isolated transistors with good matching in one multichip package
- BCR185S: For orientation in reel see package information below
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101





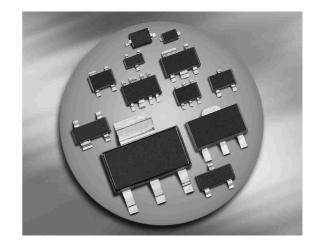
BCR185/W

BCR185S





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Туре	Markin	g	Pi	in Con	figurat	ion		Package	
BCR185	WNs	1=B	2=E	3=C	-	-	-	SOT23	
BCR185S	WNs	1=E1	2=B1	3=C2	4=E2	5=B2	6=C1	SOT363	
BCR185W	WNs	1=B	2=E	3=C	-	_	_	SOT323	





Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CEO}	50	V
Collector-base voltage	V_{CBO}	50	
Input forward voltage	V _{i(fwd)}	40	
Input reverse voltage	V _{i(rev)}	6	
Collector current	I _C	100	mA
Total power dissipation-	P _{tot}		mW
BCR185 <i>T</i> _S ≤ 102°C		200	
BCR185S, <i>T</i> _S ≤ 115°C		250	
BCR185W, <i>T</i> _S ≤ 124°C		250	
Junction temperature	$T_{\rm j}$	150	°C
Storage temperature	T _{stg}	-65 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾	R _{thJS}		K/W
BCR185		≤ 240	
BCR185S		≤ 140	
BCR185W		≤ 105	

 $^{^{1}}$ For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)



Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified **Symbol Values** Unit **Parameter** min. typ. max. **DC Characteristics** $V_{(BR)CEO}$ ٧ 50 Collector-emitter breakdown voltage $I_{\rm C}$ = 100 μ A, $I_{\rm B}$ = 0 Collector-base breakdown voltage $V_{(BR)CBO}$ 50 $I_{\rm C} = 10 \; \mu {\rm A}, \; I_{\rm E} = 0$ Collector-base cutoff current 100 nΑ I_{CBO} - $V_{\rm CB} = 40 \text{ V}, I_{\rm E} = 0$ 167 μΑ Emitter-base cutoff current *I*_{EBO} $V_{\rm EB} = 6 \text{ V}, I_{\rm C} = 0$ DC current gain¹⁾ 70 h_{FE} $I_{\rm C}$ = 5 mA, $V_{\rm CE}$ = 5 V Collector-emitter saturation voltage¹⁾ ٧ V_{CEsat} 0.3 $I_{\rm C}$ = 10 mA, $I_{\rm B}$ = 0.5 mA Input off voltage $V_{i(off)}$ 0.5 1 $I_{\rm C}$ = 100 μ A, $V_{\rm CE}$ = 5 V $V_{i(on)}$ Input on voltage 0.5 1.4 $I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 0.3 V R_1 7 13 Input resistor 10 $\mathsf{k}\Omega$ 0.19 R_1/R_2 0.21 0.24 Resistor ratio **AC Characteristics** f_{T} MHz Transition frequency 200 $I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 5 V, f = 100 MHz 3 рF Collector-base capacitance C_{cb}

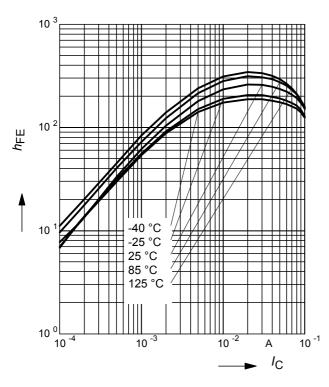
 $V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}$

¹Pulse test: t < 300µs; D < 2%



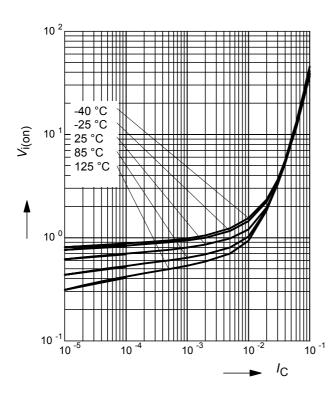
DC current gain $h_{FE} = f(I_C)$

 V_{CE} = 5 V (common emitter configuration)



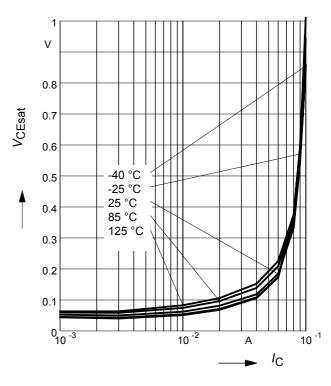
Input on Voltage $Vi_{(On)} = f(I_C)$

 $V_{CE} = 0.3V$ (common emitter configuration)



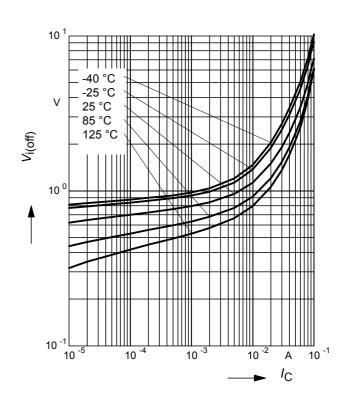
Collector-emitter saturation voltage

 $V_{\text{CEsat}} = f(I_{\text{C}}), h_{\text{FE}} = 20$



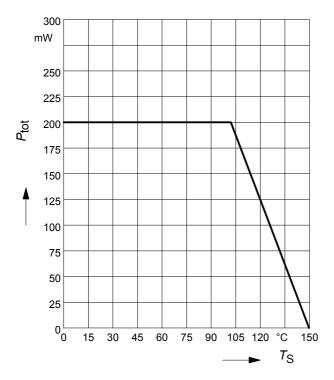
Input off voltage $V_{i(Off)} = f(I_C)$

 V_{CE} = 5V (common emitter configuration)

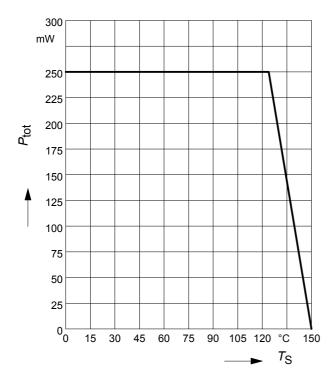




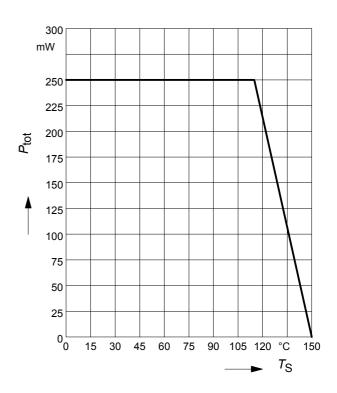
Total power dissipation $P_{tot} = f(T_S)$ BCR185



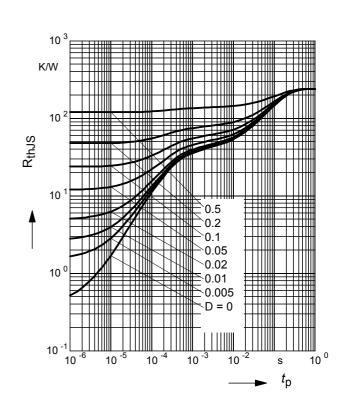
Total power dissipation $P_{tot} = f(T_S)$ BCR185W



Total power dissipation $P_{tot} = f(T_S)$ BCR185S



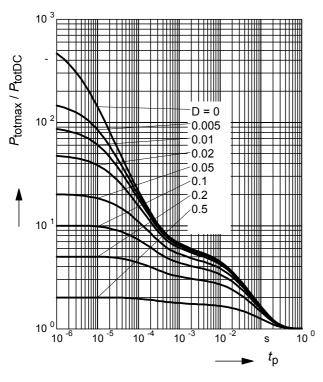
Permissible Pulse Load $R_{thJS} = f(t_p)$ BCR185



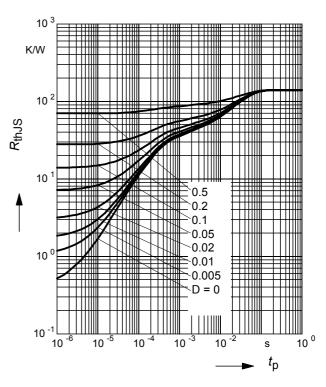


Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{\text{p}})$ BCR185

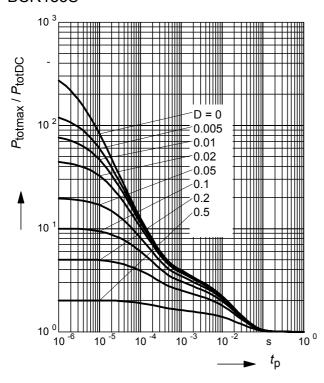


Permissible Puls Load $R_{thJS} = f(t_p)$ BCR185S

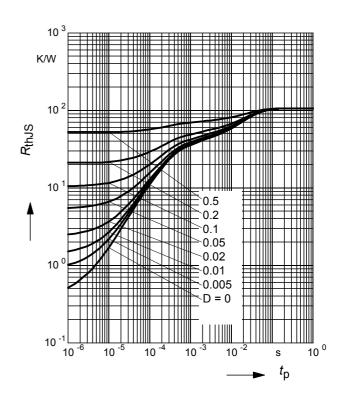


Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{\text{p}})$ BCR185S



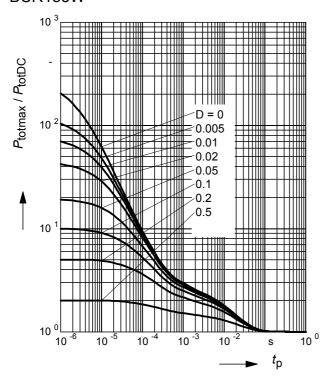
Permissible Puls Load $R_{thJS} = f(t_p)$ BCR185W





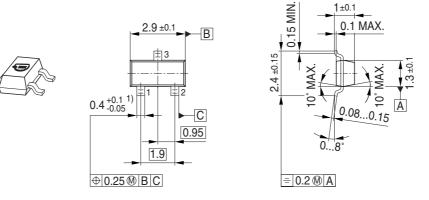
Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{\text{p}})$ BCR185W



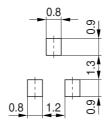


Package Outline

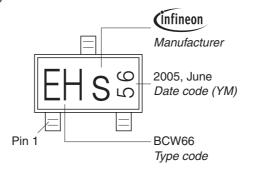


1) Lead width can be 0.6 max. in dambar area

Foot Print

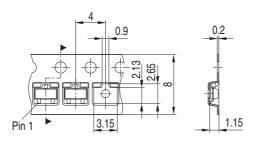


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel

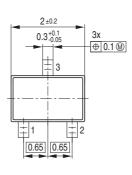


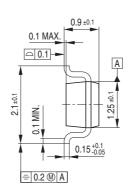
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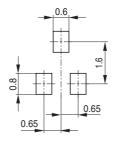
Package Outline



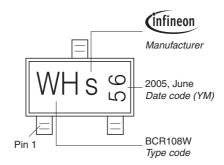




Foot Print

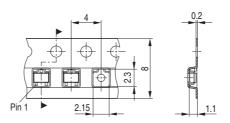


Marking Layout (Example)



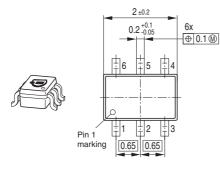
Standard Packing

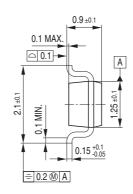
Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel



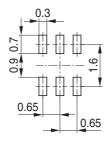


Package Outline



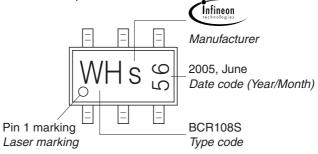


Foot Print



Marking Layout (Example)

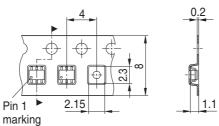
Small variations in positioning of Date code, Type code and Manufacture are possible.



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel

For symmetric types no defined Pin 1 orientation in reel.





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